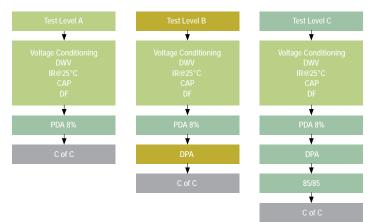


Overview

KEMET's COTS program is an extension of KEMET knowledge of high reliability test regimes and requirements. KEMET regularly supplies "up-screened" products by working with customer drawings and imposing specified design and test requirements. The COTS program offers the same high quality and high reliability components as up-screened products, but at a lower cost to the customer. This is accomplished by eliminating the need for customer-specific drawings to achieve the reliability level required for customer applications. A series of tests and inspections have been selected to provide the accelerated conditioning and 100% screening necessary to eliminate infant mortal failures from the population.

KEMET's COG dielectric features a 125°C maximum operating temperature and is considered "stable." The Electronics Components, Assemblies & Materials Association (EIA) characterizes COG dielectric as a Class I material. Components of this classification are temperature compensating and are suited for resonant circuit applications or those where Q and stability of capacitance characteristics are required. COG exhibits no change in capacitance with respect to time and voltage and boasts a negligible change in capacitance with reference to ambient temperature. Capacitance change is limited to ± 30 ppm/°C from -55°C to +125°C. All COTS testing includes voltage conditioning and postelectrical testing as per MIL-PRF-55681. For enhanced reliability, KEMET also provides the following test level options and conformance certifications:





Ordering Information

С	1206	Т	104	K	5	G	Α	С	TU
Ceramic	Case Size (L" x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance ¹	Rated Voltage (VDC)	Dielectric	Test Level	Termination Finish ²	Packaging/ Grade (C-Spec)
	0402 0603 0805 1206 1210 1812 2220	T = COTS	Two significant digits and number of zeros Use 9 for 1.0 - 9.9 pF Use 8 for 0.599 pF e.g., 2.2 pF = 229 e.g., 0.5 pF = 508	$B = \pm 0.10 \text{ pF}$ $C = \pm 0.25 \text{ pF}$ $D = \pm 0.5 \text{ pF}$ $F = \pm 1\%$ $G = \pm 2\%$ $J = \pm 5\%$ $K = \pm 10\%$ $M = \pm 20\%$	8 = 10 4 = 16 3 = 25 6 = 35 5 = 50 1 = 100 2 = 200 A = 250	G = COG	A = Testing per MIL- PRF-55681 PDA 8% B = Testing per MIL- PRF-55681 PDA 8%, DPA per EIA-469 C = Testing per MIL- PRF-55681 PDA 8%, DPA per EIA-469, Humidity per MIL-STD-202, Method 103, Condition A	C = 100% Matte Sn L = SnPb (5% Pb minimum) G = Gold (Au) 100 µin min.	See "Packaging C-Spec Ordering Options Table"

¹ Additional capacitance tolerance offerings may be available. Contact KEMET for details. ² Additional termination finish options may be available. Contact KEMET for details.

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Benefits

- -55°C to +125°C operating temperature range
- Lead (Pb)-free, RoHS and REACH compliant
- Voltage conditioning and post-electrical testing per MIL-PRF-55681, Paragraph 4.8.3.1, Standard Voltage Conditioning
- Destructive Physical Analysis (DPA) per EIA-469
- Humidity, steady state, low voltage (85/85) per MIL-STD-202, Method 103, Condition A
- RoHS Compliant (excluding SnPb end metallization option)
 No capacitance change with respect to applied rated DC
- EIA 0402, 0603, 0805, 1206, 1210, 1812, and 2220 case sizes
- DC voltage ratings of 10 V, 16 V, 25 V, 50 V, 100 V, 200 V and 250 V
- Capacitance offerings ranging from 0.5 pF up to 0.47 μ F
- Available capacitance tolerances of ±0.10 pF, ±0.25 pF, ±0.5

- pF, ±1%, ±2%, ±5%, ±10%, and ±20%
- · Certificate of compliance
- No piezoelectric noise
- · Extremely low ESR and ESL
- · High thermal stability
- High ripple current capability
- Preferred capacitance solution at line frequencies and into the MHz range
- No capacitance change with respect to applied rated DC voltage
- Negligible capacitance change with respect to temperature
- · No capacitance decay with time
- · Non-polar device, minimizing installation concerns
- SnPb end metallization option available upon request (5% Pb minimum)

Applications

Typical applications include military, space quality and high reliability electronics.

Packaging C-Spec Ordering Options Table (100% Matte Sn and SnPb Terminations)

Packaging Type ¹	Packaging/Grade Ordering Code (C-Spec)
Bulk Bag/Unmarked	Not required (Blank)
7" Reel/Unmarked	TU
13" Reel/Unmarked	7411 (EIA 0603 and smaller case sizes) 7210 (EIA 0805 and larger case sizes)
7" Reel/Unmarked/2 mm pitch ²	7081
13" Reel/Unmarked/2 mm pitch ²	7082

¹ Default packaging is "Bulk Bag". An ordering code C-Spec is not required for "Bulk Bag" packaging.

¹ The terms "Marked" and "Unmarked" pertain to laser marking option of capacitors. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. The option to laser mark is not available on these devices. For more information see "Capacitor Marking".
 ² The 2 mm pitch option allows for double the packaging quantity of capacitors on a given reel size. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".



Packaging C-Spec Ordering Options Table (Gold Termination)

Termination Finish Options	Packaging Type/Options	Packaging Ordering Code (C-Spec)
	Standard Packaging – Unmarked ³	
	Bulk Bag	Blank ¹
	Waffle Tray ²	7292
	7" Tape & Reel	TU
	13" Reel	7411 (EIA 0603 and smaller case sizes) 7210 (EIA 0805 and larger case sizes)
G = Gold (Au) 100 µin minimum	7" Tape & Reel/2 mm pitch ⁴	7081
	7" Tape & Reel – 50 pieces	T050
	7" Tape & Reel – 100 pieces	T100
	7" Tape & Reel – 250 pieces	T250
	7" Tape & Reel – 500 pieces	T500
	7" Tape & Reel – 1,000 pieces	Т1К0

¹ Default packaging is "Bulk Bag". An ordering code C-Spec is not required for "Bulk Bag" packaging.

¹ "Bulk Bag" packaging option is not available for Gold (Au) termination finish options and case sizes larger than 2225 (5664 Metric).

² "Waffle Tray" packaging option is not available for case sizes larger than 2225 (5664 Metric).

³ The terms "Marked" and "Unmarked" pertain to laser marking option of components. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. The option to laser mark is not available on these devices.

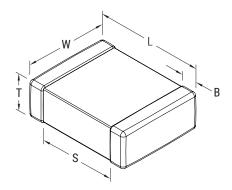
³ Reeling quantities are dependent upon chip size and thickness dimension. When ordering using the "T1K0" packaging option, 1812 through 2225 case size devices with chip thickness of ≥ 1.9 mm (nominal) may be shipped on multiple 7" reels or a single 13" reel. Additional reeling or packaging options may be available. Contact KEMET for details.

⁴ The 2 mm pitch option allows for double the packaging quantity of capacitors on a given reel size. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".

⁵ Additional reeling or packaging options may be available. Contact KEMET for details.



Dimensions – Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0402	1005	1.00 (0.040) ±0.05 (0.002)	0.50 (0.020) ±0.05 (0.002)		0.30 (0.012) ±0.10 (0.004)	0.30 (0.012)	Solder Reflow Only
0603	1608	1.60 (0.063) ±0.15 (0.006)	0.80 (0.032) ±0.15 (0.006)		0.35 (0.014) ±0.15 (0.006)	0.70 (0.028)	
0805	2012	2.00 (0.079) ±0.20 (0.008)	1.25 (0.049) ±0.20 (0.008)		0.50 (0.02) ±0.25 (0.010)	0.75 (0.030)	Solder Wave or Solder Reflow
1206	3216	3.20 (0.126) ±0.20 (0.008)	1.60 (0.063) ±0.20 (0.008)	See Table 2 for Thickness	0.50 (0.02) ±0.25 (0.010)		
1210	3225	3.20 (0.126) ±0.20 (0.008)	2.50 (0.098) ±0.20 (0.008)		0.50 (0.02) ±0.25 (0.010)	N1 / A	
1812	4532	4.50 (0.177) ±0.30 (0.012)	3.20 (0.126) ±0.30 (0.012)		0.60 (0.024) ±0.35 (0.014)	N/A	Solder Reflow Only
2220	5650	5.70 (0.224) ±0.40 (0.016)	5.00 (0.197) ±0.40 (0.016)		0.60 (0.024) ±0.35 (0.014)		

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Environmental Compliance

Lead (Pb)-free, RoHS, and REACH compliant without exemptions (excluding SnPb termination finish option).



Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±30 ppm/°C
Aging Rate (Maximum % Capacitance Loss/Decade Hour)	0%
¹ Dielectric Withstanding Voltage (DWV)	250% of rated voltage (5±1 seconds and charge/discharge not exceeding 50 mA)
² Dissipation Factor (DF) Maximum Limit at 25°C	0.1%
³ Insulation Resistance (IR) Limit at 25°C	1,000 megohm microfarads or 100 GΩ (Rated voltage applied for 120±5 seconds at 25°C)

¹ DWV is the voltage a capacitor can withstand (survive) for a short period of time. It exceeds the nominal and continuous working voltage of the capacitor.

² Capacitance and dissipation factor (DF) measured under the following conditions:

1 MHz ±100 kHz and 1.0 Vrms ±0.2 V if capacitance \leq 1,000 pF

1 kHz ±50 Hz and 1.0 Vrms ±0.2 V if capacitance > 1,000 pF

³ To obtain IR limit, divide $M\Omega$ - μ F value by the capacitance and compare to G Ω limit. Select the lower of the two limits.

Capacitance and Dissipation Factor (DF) measured under the following conditions:

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

Post Environmental Limits

High Temperature Life, Biased Humidity, Moisture Resistance										
Dielectric	Rated DC Voltage	Capacitance Value	Dissipation Factor (Maximum %)	Capacitance Shift	Insulation Resistance					
COG	All	All	0.5	0.3% or ±0.25 pF	10% of Initial Limit					



Table 1A - Capacitance Range/Selection Waterfall (0402 - 0805 Case Sizes)

		Ca	Case Size/Series					C	:04)21	Γ					C	0603	BT					C	080	5T							
	Cap		١	Volt	tag	e C	cod	e		8	4	3	5		1	2	A	8	4	3	5	1	2	A	8	4	3	5	1	2	A	
Capacitance	Code	R	ate	d V	- /olt	ad	e ('	VD	2)	5	16	25	20	:	9	200	250	10	16	25	50	100	200	250	10	16	25	50	100	200	250	
	oouc					_	nce		,	╞╴			-		-										Codes							
					bler													e Tabl	e 2 fo	or Chi	p Thi	knes	ss Din									
0.50 & 0.75 pF	508 & 758		С	D						BB	BE		BI					CF	DN													
1.0 - 9.1 pF*	109 - 919*	В	С	D	-		Ι.	V		BB	BE		BI					CF	DN													
10 - 91 pF*	100 - 910*				F	G	J	K	M		BE		BI			-		CF	CF	CF CF	CF	CF	CF	CF	DN							
100 pF	101				F	G		K	M	BB	BE		BI		BB BB	BB	BB	CF	CF		CF CF	CF	CF	CF CF	DN	DN	DN DN	DN	DN	DN DN	DN	
110 - 180 pF* 200 - 270 pF*	111 -181* 201 - 271*				F	G	J	K	M	BB	BE	_	BI	_	BB	BB BB	BB BB	CF CF	CF CF	CF CF	CF	CF CF	CF CF	CF	DN DN	DN DN	DN	DN DN	DN DN	DN	DN DN	
300 pF	301				F	G	J	K	M		BE		BI		BB	BD	BD	CF	DN													
300 pF 330 pF	301				F	G		K	M		BE		BI		BB	BD	BD	CF	DN													
360 pF	361				F	G		K	M		BE		BI		BB	ЪD	עם	CF	DN													
390 pF	301				F	G		K	M		BE		BI		BB			CF	DN													
430 pF	431				F	G		K	M		BE	_	BI	_	BB			CF	DN													
430 pF 470 pF	431				F	G	1	K	M		BE		BI		BB			CF	DN	DN	DN	DN	DN	DP	DP							
470 pr 510 - 820 pF*	4/1 511 - 821*				F	G		K	M		B		B		BB			CF	DN	DN	DN	DN	DN	DP	DP							
910 pF	911				F	G		K	M		B		B		BB			CF	DN	DN	DN	DN	DP	DP	DP							
1,000 pF	102				F	G		K	M		B		BI		BB			CF	DN	DN	DN	DN	DP	DP	DP							
1,100 pF	102				F	G	_	K	M	BB	BE	_	BI	_				CF	CF	CF	CF	CF	CH	CH	DN							
1,200 pF	122				F	G	J	K	M		BE		BI					CF	CF	CF	CF	CF	CH	CH	DN							
1,300 pF	132				F	G	J	K	M		BE		BI					CF	CF	CF	CF	CF	CH	CH	DP	DP	DP	DP	DP	DN	DN	
1,500 pF	152				F	G	J	K	M		BE		BI					CF	CF	CF	CF	CF	CH	CH	DP	DP	DP	DP	DP	DN	DN	
1,600 pF	162				F	G		K	M	BB	BE			,				CF	CF	CF	CF	CF	CH	CH	DP	DP	DP	DP	DP	DN	DN	
1,800 pF	182				F	G	J	K	M		BE	_						CF	CF	CF	CF	CF	CH	CH	DP	DP	DP	DP	DP	DN	DN	
2,000 pF	202				F	G	J	K	M	BB	BE							CF	CF	CF	CF	CF	CH	СН	DN							
2,200 pF	222				F	G	J	K	M	BB	BE							CF	CF	CF	CF	CF	CH	СН	DN							
2,400 pF	242				F	G	J	K	M									CF	CF	CF	CF	CF			DN							
2,700 pF	272				F	G	J	K	M									CF	CF	CF	CF	CF			DN							
3,000 pF	302				F	G	_	K	M									CF	CF	CF	CF	CF			DP	DP	DP	DP	DN	DN	DN	
3,300 pF	332				F	G		K	M									CF	CF	CF	CF	CF			DP	DP	DP	DP	DN	DN	DN	
3,600 pF	362				F	G			M									CF	CF	CF	CF	CF			DP	DP	DP	DP	DN	DP	DP	
3,900 pF	392				F	G		K	M									CF	CF	CF	CF	CF			DE	DE	DE	DE	DN	DP	DP	
4,300 pF	432				F	G			M									CF	CF	CF	CF	CF			DE	DE	DE	DE	DN	DP	DP	
4,700 pF	472				F	G	-	K	M									CF	CF	CF	CF	CF			DE	DE	DE	DE	DN	DP	DP	
5,100 pF	512				F	G		K	M									CF	CF	CF	CF	0.			DE	DE	DE	DE	DN	DP	DP	
5,600 pF	562				F	G		K	M									CF	CF	CF	CF				DN	DN	DN	DN	DN	DP	DP	
6,200 pF	622				F	G		K	M									CF	CF	CF	CF				DN	DN	DN	DN	DN	DG	DG	
6,800 pF	682				F	G	J	K	M									CF	CF	CF	CF				DN	DN	DN	DN	DN	DG	DG	
7,500 pF	752				F	G	J	K	M									CF	CF	CF					DN	DN	DN	DN	DN	DG	DG	
8,200 pF	822				F	G	J	K	M	1								CF	CF	CF					DN	DN	DN	DN	DN	DG	DG	
9,100 pF	912				F	G	J	K	M	1								CF	CF	CF					DN	DN	DN	DN	DN	-	-	
10,000 pF	103				F	G	J		M	1								CF	CF	CF					DN	DN	DN	DN	DP			
12,000 pF	123				F	G		K	M	1								CF	CF	CF					DN	DN	DN	DN	DE			
15,000 pF	153				F	G	J	K	M									CF	CF	CF					DN	DN	DN	DP	DG			
18,000 pF	183				F	G		K	M																DN	DN	DN	DP				
22,000 pF	223				F	G	1		M																DP	DP	DP	DF				
27,000 pF	273				F	G			M																DF	DF	DF					
33,000 pF	333				F	G			M																DG	DG	DG					
39,000 pF	393				F	G			M																DG	DG	DG					
47,000 pF	473				F	G	J		М																DG	DG	DG					
		R	ate	ed V	/olt	tag	e ('	· · · ·	· · · ·	1	16	25	20		100	200	250	10	16	25	50	100	200	250	10	16	25	50	100	200	250	
Capacitance	Cap Code			8	4	3	5		1	2	A	8	4	3	5	1	2	A	8	4	3	5	1	2	A							
		Case Size/Series						C04)2T						C	0603	Т					C	0805	т								

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91) KEMET reserves the right to substitute product with an improved temperature characteristic, tighter capacitance tolerance and/or higher voltage capability within the same form factor (configuration and dimensions).

These products are protected under US Patents 7,172,985 & 7,670,981, other patents pending, and any foreign counterparts.



Table 1B - Capacitance Range/Selection Waterfall (1210 - 2225 Case Sizes)

27,000 pF 273 F G J K M EB FB			Τ	Ca	ase Size/Series						C	120	6 T					C	121(T				C18	12T		C	2220	DT			
Caba Code Rated Voltage (VDC) P <th></th> <th>Can</th> <th></th> <th></th> <th>۷</th> <th>olta</th> <th>age</th> <th>e C</th> <th>Code</th> <th>е</th> <th></th> <th>8</th> <th>4</th> <th>3</th> <th>5</th> <th>1</th> <th>2</th> <th>A</th> <th>8</th> <th>4</th> <th>3</th> <th>5</th> <th>1</th> <th>2</th> <th>A</th> <th>5</th> <th>1</th> <th>2</th> <th>A</th> <th>5</th> <th>1</th> <th>2</th>		Can			۷	olta	age	e C	Code	е		8	4	3	5	1	2	A	8	4	3	5	1	2	A	5	1	2	A	5	1	2
Capacitance Tolerance Copacitance Tolerance Product Availability and Chip Thickness Codes 1.0-31 pf* 100-510* 8 0 <th>Capacitance</th> <th></th> <th></th> <th>Ra</th> <th>te</th> <th>d Vo</th> <th>olta</th> <th>ag</th> <th>e (\</th> <th>VD</th> <th>C)</th> <th>10</th> <th>16</th> <th>25</th> <th>50</th> <th>8</th> <th>00</th> <th>50</th> <th>10</th> <th>16</th> <th>25</th> <th>50</th> <th>8</th> <th>00</th> <th>50</th> <th>50</th> <th>8</th> <th>00</th> <th>50</th> <th>50</th> <th>8</th> <th>200</th>	Capacitance			Ra	te	d Vo	olta	ag	e (\	VD	C)	10	16	25	50	8	00	50	10	16	25	50	8	00	50	50	8	00	50	50	8	200
1091 pF* 100-910* B C D F G J K E			ŀ		C	•				9						-		Prod	uct Av	vailat	oility a	and C	hip T	hickn	ess C	Codes					-	~
10191P* 00191P* 01431* F G J K M E E E E E E F F G J K M E E E E E F F G J K M E E E E E F F F G J K M E E E E E F F F G J K M E E E E E F	10.01pF*	100 010*	* 1		<u>~</u>	_	lera	an	ce			ED	ED	ED	ED	ED	ED							_		ons				-		
100-30 pF 101-431* F G J X M EB EB EB EB EB EB EB FB							F	G	1.	к	м																					
470-910_P* 471-911* F G J K M BE EB																																
11000 pF 112 F G J K M BE EB <	470 - 910 pF*	471 - 911*	*				F		J	K	M	EB	EB	EB	EB	EB	EB	EB	FB	FB	FB	FB	FB	FB	FB	GB	GB	GB	GB			
1.200 pF 1122 F G J K M EB	1,000 pF	102					F	G	J	K	M	EB	EB	EB	EB	EB	EE	EE	FB	FB	FB	FB	FB	FB	FB	GB	GB	GB	GB	1		
1.300 pF 1320 pF 6 b J K M EB	1,100 pF	112							J	K	M	EB	EB	EB	EB	EB	EB		FB	FB		FB	FB	FB	FB	GB	GB					
1.500 pF 152 F G J K K B B E F F G J K K B B B F F F G J K K B B B F F F G J K K B B B B F F F G J K K B B B B B F	1,200 pF												1														-		-			
1.600 pF 162 I K EB EB EB ED ED ED ED FB FE FF G J K M EB EB EB EB EB EB EB FB													1			-	-	-							-		-		-			
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2.000 pF 2020 F G J X M EB EB EB ED					4	_	_		_	_	_			_																		
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\$ $$100 \text{ pF}$ 512 F G J K M ED ED <th< td=""><td>4,300 pF</td><td>432</td><td></td><td></td><td></td><td></td><td>F</td><td>G</td><td>J</td><td>K</td><td>M</td><td>EC</td><td>EC</td><td>EC</td><td>EC</td><td>EC</td><td>EB</td><td>EB</td><td>FB</td><td>FB</td><td>FB</td><td>FB</td><td>FF</td><td>FF</td><td>FF</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></th<>	4,300 pF	432					F	G	J	K	M	EC	EC	EC	EC	EC	EB	EB	FB	FB	FB	FB	FF	FF	FF							
5,600 pF 562 F G J K M ED	4,700 pF	472					F	G	J	K	M	EC	EC	EC	EC	EC	EB	EB	FF	FF	FF	FF	FG	FG	FG	GB	GB	GD	GD			
6,200 pF 622 F G J K M EB EB EB EB EB EB EB EB FB FB FB FG FB	5,100 pF	512						G	J			ED	ED	ED	ED	ED		EB	FB	FB	FB	FB	FG	FG	FG							
6,800 pF 682 F G J K M EB									1.1																-	GB	GB	GH	GH			
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39,000 pF 393 F G J K M EC FB							F	G					EB	EB	EB	EE				FB	FB	FB	FB	FG	FG	GB	GB		GB	JE	JB	JB
47,000 pF 473 473 F G J K M EC EC EC EC EE EH L FB FB FB FB FB FJ GB GB GB GD GD JB JB JB JB JB JB JB JB FB FB FB FB FB FB FB FB FJ GB	33,000 pF	333					F	G	J	K	M	EB	EB	EB	EB	EE			FB	FB	FB	FB	FB	FH	FH	GB	GB	GB	GB	JB	JB	JB
56,000 pF 563 F G J K M ED ED ED EF EF FB	39,000 pF	393							J			EC	EC	EC		EH			FB	FB		FB	FE	FH	FH	GB	GB		GB	JB	JB	JB
68,000 pF 683 F G J K M EF													1	-		EH								FJ	FJ		-		-		JB	JB
82,000 pF 823 I F G J K M EH													1														-				JB	JB
0.10 µF 104 F G J K M EH EH <t< td=""><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>1</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>-</td><td></td><td></td><td></td><td>-</td><td></td><td></td><td></td><td>JB</td><td>JB</td></t<>													1										-				-				JB	JB
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0.15 µF 154 F G J K M 0.18 µF 184 F G J K M 0.22 µF 224 F G J K M F G J K M 0.22 µF 224 F G J K M F G J K M 0.27 µF 274 F G J K M F G J K M 0.33 µF 334 F G J K M F F J K M JB		-										EH	EH	EH									FM					GM	GM			JD
0.18 μF 184 F G J K M F G J K M J J K M J J K M J J K M J K M J J K M J K M J J K M J J K M J J K M J J K M J J K M J J K M J J K M J J K M J J K M J K K K J K K J K K J K K J J K K J J K K J J K K J J K K J J K K J J K J J J J J J J J J J J J										K	M																					JD JG
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				Ra	te	d Vo	olta	ag	e (\	VD	C)	10	16	25	50	100	200	250	10	16	25	50	100	200	250	50	100	200	250	50	100	200
Capacitance Code Voltage Code 8 4 3 5 1 2 A 8 4 3 5 1 2 A 5 1 2 A 5 1 2 A 5 1	Capacitance	Cap Code	╞	Voltage Code			8	4	3	5	1	2	A	8	4	3	5		2	A	5	1	2		5	1	2					
Case Size/Series C1206T C1210T C1812T C222										. (1206	Т					C	1210	т				C18	12T		C	2220	T				

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91) KEMET reserves the right to substitute product with an improved temperature characteristic, tighter capacitance tolerance and/or higher voltage capability within the same form factor (configuration and dimensions).

These products are protected under US Patents 7,172,985 & 7,670,981, other patents pending, and any foreign counterparts.



Table 2A - Chip Thickness/Tape & Reel Packaging Quantities

Thickness	Case	Thickness ±	Paper Q	uantity ¹	Plastic (Quantity		
Code	Size ¹	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel		
BB	0402	0.50 ± 0.05	10,000	50,000	0	0		
BD	0402	0.55 ± 0.05	10,000	50,000	0	0		
CF	0603	0.80 ± 0.07	4,000	15,000	0	0		
CH	0603	0.85 ± 0.07	4,000	10,000	0	0		
DN	0805	0.78 ± 0.10	4,000	15,000	0	0		
DP	0805	0.90 ± 0.10	4,000	15,000	0	0		
DE	0805	1.00 ± 0.10	0	0	2,500	10,000		
DF	0805	1.10 ± 0.10	0	0	2,500	10,000		
DG	0805	1.25 ± 0.15	0	0	2,500	10,000		
EB	1206	0.78 ± 0.10	0	0	4,000	10,000		
EC	1206	0.90 ± 0.10	0	0	4,000	10,000		
ED	1206	1.00 ± 0.10	0	0	2,500	10,000		
EE	1206	1.10 ± 0.10	0	0	2,500	10,000		
EF	1206	1.20 ± 0.15	0	0	2,500	10,000		
EH	1206	1.60 ± 0.20	0	0	2,000	8,000		
FB	1210	0.78 ± 0.10	0	0	4,000	10,000		
FC	1210	0.90 ± 0.10	0	0	4,000	10,000		
FE	1210	1.00 ± 0.10	0	0	2,500	10,000		
FF	1210	1.10 ± 0.10	0	0	2,500	10,000		
FG	1210	1.25 ± 0.15	0	0	2,500	10,000		
FH	1210	1.55 ± 0.15	0	0	2,000	8,000		
FM	1210	1.70 ± 0.20	0	0	2,000	8,000		
FJ	1210	1.85 ± 0.20	0	0	2,000	8,000		
FK	1210	2.10 ± 0.20	0	0	2,000	8,000		
GB	1812	1.00 ± 0.10	0	0	1,000	4,000		
GD	1812	1.25 ± 0.15	0	0 0	1,000	4,000		
GH GG	1812 1812	1.40 ± 0.15	0	0	1,000 1,000	4,000		
GK	1812	1.55 ± 0.10	0	0	1,000	4,000 4,000		
GJ		1.60 ± 0.20	0	0	1,000			
GN	1812 1812	1.70 ± 0.15	0		1,000	4,000		
GN	1812	1.70 ± 0.20 2.00 ± 0.20	0	0 0	500	4,000 2,000		
JB	2220	2.00 ± 0.20 1.00 ± 0.15	0	0	1,000	2,000 4,000		
JD	2220	1.30 ± 0.15 1.30 ± 0.15	0	0	1,000	4,000 4,000		
JE	2220	1.30 ± 0.15 1.40 ± 0.15	0	0	1,000	4,000 4,000		
JF	2220	1.40 ± 0.15 1.50 ± 0.15	0	0	1,000	4,000		
JG	2220	1.70 ± 0.15	0	0	1,000	4,000 4,000		
JL	2220	2.00 ± 0.20	0	0	500	4,000 2,000		
			7" Reel	13" Reel	7" Reel	13" Reel		
Thickness Code	Case Size1	Thickness ± Range (mm)		uantity ¹	Plastic Quantity			

Package quantity based on finished chip thickness specifications.

¹ If ordering using the 2 mm Tape and Reel pitch option, the packaging quantity outlined in the table above will be doubled. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".



Table 2B – Bulk Packaging Quantities

Deekeri		Loose Pa	ackaging							
Packagi	ng Type	Bulk Bag (default)								
Packagin	g C-Spec ¹	N/	Ά ²							
Case	Size	Packaging Quantities (pieces/unit packagin								
EIA (in)	Metric (mm)	Minimum	Maximum							
0402	1005									
0603	1608									
0805	2012		50,000							
1206	3216									
1210	3225	1								
1808	4520									
1812	4532]								
1825	4564	564								
2220	5650]								
2225	5664									

¹ The "Packaging C-Spec" is a 4 to 8 digit code which identifies the packaging type and/or product grade. When ordering, the proper code must be included in the 15th through 22nd character positions of the ordering code. See "Ordering Information" section of this document for further details. Commercial Grade product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging. Contact KEMET if you require a bulk bag packaging option for Automotive Grade products.

² A packaging C-Spec (see note 1 above) is not required for "Bulk Bag" packaging (excluding Anti-Static Bulk Bag and Automotive Grade products). The 15th through 22nd character positions of the ordering code should be left blank. All product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging.



Table 3 – Chip Capacitor Land Pattern Design Recommendations per IPC-7351

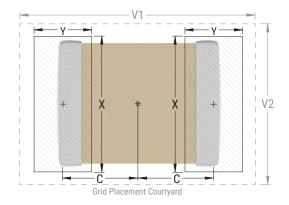
EIA Size Code	Metric Size Code		Maxi	sity Lev mum (I rotrusic	Most))	1	Media	sity Lev an (Nor rotrusic	ninal))	Density Level C: Minimum (Least) Land Protrusion (mm)							
Coue	Coue	C	Y	X	V1	V2	C	Y	X	V1	V2	C	Y	X	V1	V2			
0402	1005	0.50	0.72	0.72	2.20	1.20	0.45	0.62	0.62	1.90	1.00	0.40	0.52	0.52	1.60	0.80			
0603	1608	0.90	1.15	1.10	4.00	2.10	0.80	0.95	1.00	3.10	1.50	0.60	0.75	0.90	2.40	1.20			
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70			
1206	3216	1.60	1.35	1.90	5.60	2.90	1.50	1.15	1.80	4.70	2.30	1.40	0.95	1.70	4.00	2.00			
1210	3225	1.60	1.35	2.80	5.65	3.80	1.50	1.15	2.70	4.70	3.20	1.40	0.95	2.60	4.00	2.90			
1210 ¹	3225	1.50	1.60	2.90	5.60	3.90	1.40	1.40	2.80	4.70	3.30	1.30	1.20	2.70	4.00	3.00			
1812	4532	2.15	1.60	3.60	6.90	4.60	2.05	1.40	3.50	6.00	4.00	1.95	1.20	3.40	5.30	3.70			
2220	5650	2.75	1.70	5.50	8.20	6.50	2.65	1.50	5.40	7.30	5.90	2.55	1.30	5.30	6.60	5.60			

¹ Only for capacitance values $\ge 22 \ \mu F$

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805, and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC–7351).

Image below based on Density Level B for an EIA 1210 case size.





Soldering Process

Recommended Soldering Technique:

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

Recommended Reflow Soldering Profile:

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Terminat	ion Finish
Tomereature	SnPb	100% Matte Sn
Preheat/Soak		
Temperature Minimum (T _{Smin})	100°C	150°C
Temperature Maximum (T _{Smax})	150°C	200°C
Time (t_s) from T_{smin} to T_{smax}	60 – 120 seconds	60 – 120 seconds
Ramp-Up Rate (T _L to T _p)	3°C/second maximum	3°C/second maximum
Liquidous Temperature (T_L)	183°C	217°C
Time Above Liquidous (t_L)	60 – 150 seconds	60 – 150 seconds
Peak Temperature (T _P)	235°C	260°C
Time Within 5°C of Maximum Peak Temperature (t _p)	20 seconds maximum	30 seconds maximum
Ramp-Down Rate $(T_p to T_L)$	6°C/second maximum	6°C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum

Note 1: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.

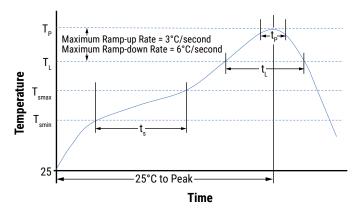




Table 4 – Performance & Reliability: Test Methods and Conditions

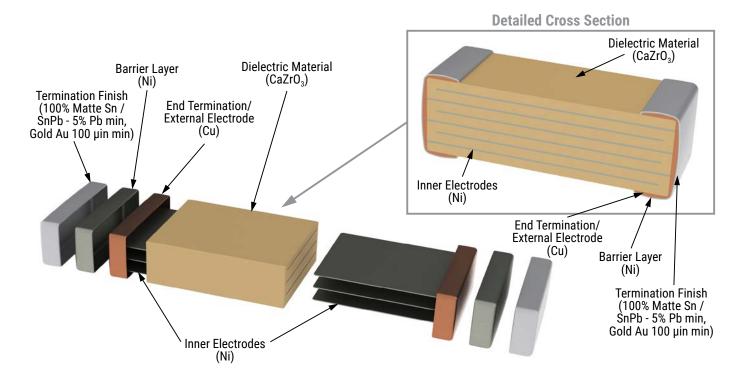
Stress	Reference	Test or Inspection Method
Terminal Strength	JIS-C-6429	Appendix 1, Note: Force of 1.8 kg for 60 seconds.
Board Flex	JIS-C-6429	Appendix 2, Note: Standard termination system – 2.0 mm (minimum) for all except 3 mm for COG. Flexible termination system – 3.0 mm (minimum).
		Magnification 50 X. Conditions:
Saldarability	J-STD-002	a) Method B, 4 hours at 155°C, dry heat at 235°C
Solderability	J-31D-002	b) Method B at 215°C category 3
		c) Method D, category 3 at 260°C
Temperature Cycling	JESD22 Method JA-104	1,000 Cycles (-55°C to +125°C). Measurement at 24 hours +/- 4 hours after test conclusion.
Biased Humidity MIL-STD-202 Method 103		Load Humidity: 1,000 hours 85°C/85% RH and rated voltage. Add 100 K ohm resistor. Measurement at 24 hours +/- 4 hours after test conclusion. Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours +/- 4 hours after test conclusion.
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Measurement at 24 hours +/- 4 hours after test conclusion.
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required – 300, maximum transfer time – 20 seconds, dwell time – 15 minutes. Air – Air.
High Temperature Life	MIL-STD-202 Method 108 /EIA-198	1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 2 X rated voltage applied.
Storage Life	MIL-STD-202 Method 108	150°C, 0 VDC for 1,000 hours.
Vibration	MIL-STD-202 Method 204	5 g's for 20 min., 12 cycles each of 3 orientations. Note: Use 8" X 5" PCB 0.031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F.
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemical, OKEM Clean or equivalent.

Storage and Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature-reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



Construction



Capacitor Marking (Optional)

Laser marking option is not available on:

- COG, Ultra Stable X8R and Y5V dielectric devices
- · EIA 0402 case size devices
- EIA 0603 case size devices with Flexible Termination option.
- KPS Commercial and Automotive grade stacked devices.

These capacitors are supplied unmarked only.



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

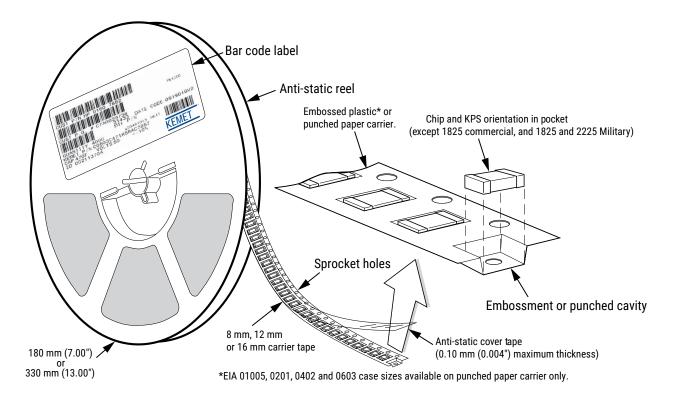


Table 5 – Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

	Таре	Embosse	ed Plastic	Punched Paper		
EIA Case Size	Size (W)*	7" Reel	13" Reel	7" Reel	13" Reel	
		Pitch (P ₁)*		Pitch (P ₁)*		
01005 - 0402	8			2	2	
0603	8			2/4	2/4	
0805	8	4	4	4	4	
1206 - 1210	8	4	4	4	4	
1805 - 1808	12	4	4			
≥ 1812	12	8	8			
KPS 1210	12	8	8			
KPS 1812 and 2220	16	12	12			
Array 0612	8	4	4			

*Refer to Figures 1 and 2 for W and P₁ carrier tape reference locations. *Refer to Tables 6 and 7 for tolerance specifications.

New 2 mm Pitch Reel Options*

Packaging Ordering Code (C-Spec)	Packaging Type/Options
C-3190	Automotive grade 7" reel unmarked
C-3191	Automotive grade 13" reel unmarked
C-7081	Commercial grade 7" reel unmarked
C-7082	Commercial grade 13" reel unmarked

* 2 mm pitch reel only available for 0603 EIA case size. 2 mm pitch reel for 0805 EIA case size under development.

Benefits of Changing from 4 mm to 2 mm Pitching Spacing

- Lower placement costs.
- Double the parts on each reel results in fewer reel changes and increased efficiency.
- Fewer reels result in lower packaging, shipping and storage costs, reducing waste.



Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

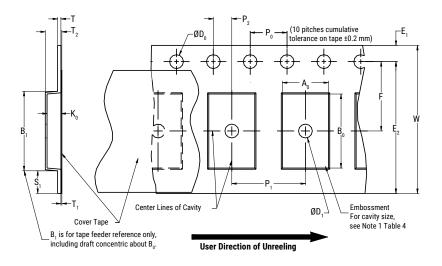


Table 6 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D ₀	D ₁ Minimum Note 1	E ₁	P ₀	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T ₁ Maximum
8 mm		1.0 (0.039)				25.0 (0.984)			
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	30	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
16 mm		(0.059)				(1.181)			
		,	Variable Dime	ensions — Mil	limeters (Inch	ies)			
Tape Size	Tape SizePitch B_1 Maximum Note 4 E_2 MinimumF P_1 T_2 MaximumW Maximum $A_0, B_0 \& K_0$							& K ₀	
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)		
12 mm	Single (4 mm) and double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Not	te 5
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)		

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of the embossment location and the hole location shall be applied independently of each other.

2. The tape with or without components shall pass around R without damage (see Figure 6.)

3. If S₁ < 1.0 mm, there may not be enough area for a cover tape to be properly applied (see EIA Standard 481, paragraph 4.3, section b.)

4. B, dimension is a reference dimension for tape feeder clearance only.

5. The cavity defined by A_{μ} , B_{μ} and K_{μ} shall surround the component with sufficient clearance that:

(a) the component does not protrude above the top surface of the carrier tape.

(b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

(c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3.)

(d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4.)

(e) for KPS product, A_{n} and B_{n} are measured on a plane 0.3 mm above the bottom of the pocket.

(f) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.



Figure 2 – Punched (Paper) Carrier Tape Dimensions

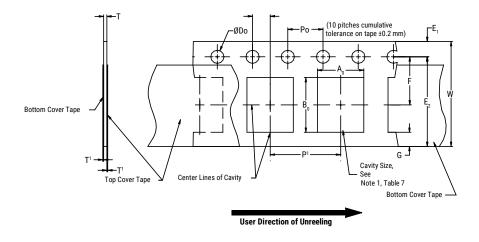


Table 7 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D ₀	E ₁	P ₀	P ₂	T ₁ Maximum	G Minimum	R Reference Note 2		
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) maximum	0.75 (0.030)	25 (0.984)		
	Variable Dimensions – Millimeters (Inches)								
Tape Size	Pitch	E2 Minimum	F	P ₁	T Maximum	W Maximum	A ₀ B ₀		
8 mm	Half (2 mm)	6.25	3.5 ±0.05 (0.138 ±0.002)	2.0 ±0.05 (0.079 ±0.002)	1.1 (0.098)	8.3 (0.327)	Note 1		
8 mm	Single (4 mm)	(0.246)		4.0 ±0.10 (0.157 ±0.004)		8.3 (0.327)	NOLE I		

1. The cavity defined by A_{α} , B_{α} and T shall surround the component with sufficient clearance that:

a) the component does not protrude beyond either surface of the carrier tape.

b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

c) rotation of the component is limited to 20° maximum (see Figure 3.)

d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4.)

e) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.

2. The tape with or without components shall pass around R without damage (see Figure 6.)



Packaging Information Performance Notes

- 1. Cover Tape Break Force: 1.0 kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of $300 \pm 10 \text{ mm/minute}$.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

Figure 3 – Maximum Component Rotation

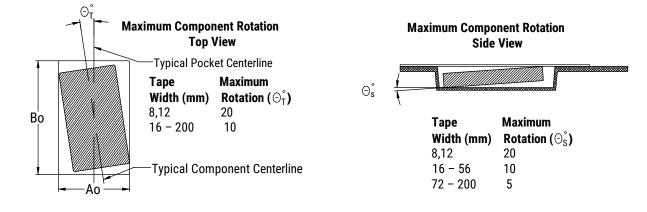


Figure 4 – Maximum Lateral Movement

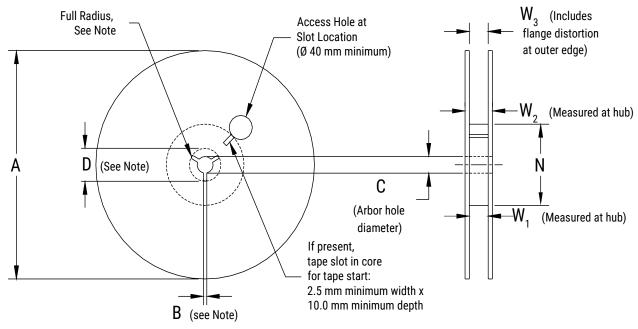


Figure 5 – Bending Radius





Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 8 – Reel Dimensions

Metric will govern

	Constant Dimensions – Millimeters (Inches)							
Tape Size	А	B Minimum	С	D Minimum				
8 mm	178 ±0.20	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)					
12 mm	(7.008 ±0.008) or			20.2 (0.795)				
16 mm	330 ±0.20 (13.000 ±0.008)		()	()				
	Variable Dimensions – Millimeters (Inches)							
Tape Size	N Minimum	W ₁	W ₂ Maximum	W ₃				
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)					
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference				
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)					



Figure 7 – Tape Leader & Trailer Dimensions

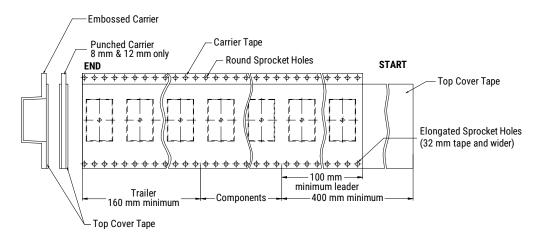


Figure 8 – Maximum Camber





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